

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lange of the applicatio customer's to unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the

July 2012

FPF3003 IntelliMAX[™] Full Functional Input Power Path Management Switch for Dual-Battery Portable System

Features

SEMICONDUCTOR

- 2.3V to 5.5V Input Voltage Operating Range
- Low R_{ON} between Battery and Load Maximum 50mΩ at V_{IN} = 4.2V
- Low R_{ON} between Charger and Battery Maximum 125mΩ at V_{IN} = 4.2V
- Maximum DC Current for Load Switch: 2.5A
- Maximum DC Current for Charge Switch: 1.5A
- Slew Rate Controlled to 30µs Nominal Rise Time
- Seamless Break-Before-Make Transition
- Quiescent Current: 30µA Typical
- Thermal Shutdown
- Reverse Current Blocking (RCB) between Battery A and Battery B
- RESET Timer Delay: 7s Typical
- ESD Protected:
 - Human Body Model: >2.5kV
 - Charged Device Model: >1.5kV
 - IEC 61000-4-2 Air Discharge: >15kV
 - IEC 61000-4-2 Contact Discharge: >8kV
- 1.6mm X 1.6mm, 16-Bump, 0.4mm Pitch, WLCSP

Applications

- Dual-Battery Cell phone
- Dual-Battery Portable Equipment

tterv Cell phone

•							
Part Number	Top Mark	(Charger-Battery) Max. R _{oN} at 4.2V _{IN}	(Battery-Load) Max. R _{ON} at 4.2V _{IN}	Typical t _R	Package		
FPF3003UCX	QW	125mΩ	50mΩ	30µs	16-Bump, 0.4mm Pitch, 1.6mm x 1.6mm WLCSP		

Ordering Information

© 2011 Fairchild Semiconductor Corporation FPF3003 • Rev. 1.0.0

www.fairchildsemi.com

Description The FPF3003 is a single-chip solution for dual-battery power-path switching, including integrated P-channel

power-path switching, including integrated P-channel switches and analog control features. The input voltage range operates from 2.3V to 5.5V. The device selects one of two batteries to provide power to the system, enabling one battery to be charged by the external battery charger.

The FPF3003 has battery voltage monitoring to determine if the battery is under voltage. Special driver and digital circuitry allows the device to switch quickly between battery A and battery B, which allows hot swapping of battery packs. Maximum current from battery to load per channel is limited to a constant 2.5A and internal thermal shutdown circuits protect the part during fault conditions.

The FPF3003 is available in a 1.6mm x 1.6mm, 16-bump, Wafer-Level Chip-Scale Package (WLCSP).



Pin Configuration



Figure 3. Pin Assignments (Top View)



Figure 4. Pin Assignments (Bottom View)

Pin Description

Pin #	Name	Description		
A1	LOBAT	Low Battery A Voltage Input . Connect to the resistive divider to set the trip level for chip-on moment. If LOBAT is less than 0.8V, V_{OUT} is connected to BATB.		
A2	CHGIN	Charging Input. Charging path input.		
A3, A4	BATA	Supply Input. Battery A voltage input.		
B1	STAT	Battery Selector Status . Open-drain output. HIGH (Hi-Z) means battery A connects to VOUT. LOW means battery B connects to VOUT.		
B2	BATBID	Battery B Indicator . Connect this pin with the ID pin at the battery pack of BATB. HIGH means battery B absent; LOW means battery B present.		
B3,B4	VOUT	Switch Output. Connect to system load.		
C1	ADPIN	Adapter Input. 5V input for battery charger.		
C2	BATAID	Battery A Indicator . Connect this pin with the ID pin at the battery pack of BATA. HIGH means battery A absent; LOW means battery A present.		
C3,C4	BATB	Supply Input. Battery B voltage input.		
D1	GND	Ground		
D2	RESETB	Reset Input. Active LOW. Both system path switches are disconnected from system load.		
D3	BATSEL	Battery Selection Input . HIGH means to switch battery B to VOUT; LOW means to switch battery A to VOUT.		
D4	CHGSEL	Charge Selection Input. HIGH means to charge battery B: LOW means to charge battery A.		

Absolute Maximum Ratings

Stresses exceeding the Absolute Maximum Ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Min.	Max.	Unit	
V _{IN}	All Pins To GND		-0.3	6.0	V
1	Maximum Continuous Switch Current to Load			2.5	Α
I _{SW}	Maximum Continuous Switch Current to Charger			1.5	Α
PD	Power Dissipation at TA	= 25°C		1.7	W
T _{STG}	Operating and Storage	Junction Temperature	-65	150	°C
Θ _{JA}	Thermal Resistance, Ju (1in. Square Pad of 2oz		72 ⁽¹⁾	°C/W	
		Human Body Model, JESD22-A114	2.5		
	Electrostatic Discharge Capability	Charged Device Model, JESD22-C101	1.5		
ESD		Air Discharge (BATA, BATB, ADPIN to GND), IEC61000-4-2 System Level	15.0		kV
		Contact Discharge (BATA, BATB, ADPIN to GND), IEC61000-4-2 System Level	8.0		

Note:

1. Measured using 2S2P JEDEC std. PCB.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameters	Min.	Max.	Unit
N	ADPIN	4.6	5.5	V
VIN	BATA, BATB	2.3	5.5	V
T _A	Ambient Operating Temperature	-40	85	°C

FPF3003 — IntelliMAX™ Full Functional Input Power Path Management Switch for Dual-Batterv Portable Systems

Electrical Characteristics

ADPIN=4.6 to 5.5V, $V_{BATA}=V_{BATB}=2.3$ to 5.5V, $T_A=-40$ to 85°C unless otherwise noted. Typical values are at ADPIN=5V, CHGIN=V_{BATA}=V_{BATB}=4.2V, RESETB=HIGH, and $T_A=25$ °C.

Symbol	Parameters	Condition	Min.	Тур.	Max.	Unit
Static Char	acteristics					
VADPIN	Adapter Input Voltage		4.6		5.5	V
M		ADPIN Rising		4.5		v
VADPIN_TH	ADPIN Threshold	ADPIN Falling		4.2		
V _{bata} , V _{batb}	Battery Input Voltage		2.3		5.5	V
Ι _Q	Quiescent Current	I _{OUT} =0mA		30		μA
		$V_{BATA} = V_{BATB} = 5.5V, I_{OUT} = 300mA, T_A = 25^{\circ}C^{(2)}$		34		
	On Resistance to Load Switch, BATA	$V_{BATA}=V_{BATB}=4.2V$, $I_{OUT}=300mA$, $T_{A}=25^{\circ}C$		38	50	
	or BATB to VOUT	$V_{BATA}=V_{BATB}=3.7V, I_{OUT}=300mA, T_{A}=25^{\circ}C$		43	55	
		$V_{BATA}=V_{BATB}=2.3V, I_{OUT}=300mA, T_{A}=25^{\circ}C^{(2)}$		62		
		$V_{BATA}=V_{BATB}=5.5V, I_{CHG}=200mA, T_{A}=25^{\circ}C^{(2)}$		66		mΩ
_	On Resistance to	V _{BATA} =V _{BATB} =4.2V, I _{CHG} =200mA, T _A =25°C		73	90	
Ron	Charger Switch, CHGIN to BATA	$V_{BATA}=V_{BATB}=3.7V$, $I_{CHG}=200mA$, $T_{A}=25^{\circ}C$		80	95	
		V _{BATA} =V _{BATB} =2.3V, I _{CHG} =200mA, T _A =25°C ⁽²⁾		101		
	On Resistance to Charger Switch, CHGIN to BATB	$V_{BATA}=V_{BATB}=5.5V, I_{CHG}=200mA, T_{A}=25^{\circ}C^{(2)}$		92		
		V _{BATA} =V _{BATB} =4.2V, I _{CHG} =200mA, T _A =25°C		99	125	
		V _{BATA} =V _{BATB} =3.7V, I _{CHG} =200mA, T _A =25°C		105	130	
		V _{BATA} =V _{BATB} =2.3V, I _{CHG} =200mA, T _A =25°C ⁽²⁾		128		
	Input Logic HIGH	V _{BATA} =V _{BATB} =2.3V – 5.5V, CHGSEL, BATSEL	0.90			
V _{IH}	Voltage	V _{BATA} =V _{BATB} =2.3V – 5.5V, RESETB	1.15			V
	-	V _{BATA} =V _{BATB} =2.3V – 5.5V, BATAID, BATBID	1.70			
	Input Logic LOW Voltage	V _{BATA} =V _{BATB} =2.3V – 5.5V, CHGSEL, BATSEL			0.6	v
VIL		V _{BATA} =V _{BATB} =2.3V – 5.5V, RESETB			0.8	
		V _{BATA} =V _{BATB} =2.3V – 5.5V, BATAID, BATBID			0.9	
V _{STAT_LO}	STAT Logic LOW Voltage	I _{SINK} =1mA			0.3	V
V_{LOBAT}	LOBAT Threshold	$V_{BATA}=V_{BATB}=2.3V-5.5V$		0.8		V
t _{lobat}	LOBAT De-Glitch Time	V _{BATA} =V _{BATB} =2.3V – 5.5V		1.3		ms
		Shutdown Threshold		150		°C
T_{SD}	Thermal Shutdown	Return from Shutdown		140		
		Hysteresis		10		
V _{DROOP_OUT}	Output Voltage Droop while Battery Switching	V_{BATA} =4.2V, V_{BATB} =4.2V, Switching from V_{BATA} → V_{BATB} , R_L =100Ω, C_{OUT} =10µF			100	mV

Continued on the following page...

Electrical Characteristics

ADPIN=4.6 to 5.5V, $V_{BATA}=V_{BATB}=2.3$ to 5.5V, $T_A=-40$ to 85°C unless otherwise noted. Typical values are at ADPIN=5V, CHGIN=V_{BATA}=V_{BATB}=4.2V, RESETB=HIGH, and $T_A=25$ °C.

Symbol	Parameters	Condition	Min.	Тур.	Max.	Unit
Reverse Cu	urrent Blocking betwee	en V _{BATA} and V _{BATB}				
V_{T_RCB}	RCB Protection Trip Point	$V_{OUT} - V_{BATA}$ or V_{BATB}		20		mV
$V_{R_{RCB}}$	RCB Protection Release Trip Point	V _{BATA} or V _{BATB} -V _{OUT}		30		mV
	Hysteresis			50		mV
Dynamic C	haracteristics: See De	finitions Below				
t _R	V _{OUT} Rise Time ^(2,3,4)	V _{BATA} =V _{BATB} =4.2V, R _I =100Ω, T _A =25°C,		30		μs
t _{DON}	Turn-On Delay ^(2,3,4)	$C_L=10\mu F$, BATAID=HIGH to LOW,		5		μs
t _{on}	Turn-On Time ^(2,3,4)	BATBID=HIGH		35		
t⊧	V _{OUT} Fall Time ^(2,3,5)	$V_{BATA} = V_{BATB} = 4.2V, R_{I} = 100\Omega, T_{A} = 25^{\circ}C,$		2.5		ms
t _{DOFF}	Turn-Off Delay ^(2,3,5)	C _L =10µf, BATAID=LOW to HIGH,		0.1		ms
t _{OFF}	Turn-Off Time ^(2,3,5)	BATBID=HIGH		2.6		ms
t _{DSEL}	Selection Delay ^(2,3)	$V_{BATA}=V_{BATB}=4.2V$, $R_L=100\Omega$, $T_A=25^{\circ}C$, $C_L=10\mu$ F, CHGSEL or BATSEL=LOW to HIGH		1		ms
t _{DRST}	RESET Timer Delay ^(2,3)	$V_{BATA}=V_{BATB}=4.2V$, $R_L=100\Omega$, $T_A=25^{\circ}C$, $C_L=10\mu$ F, RESETB=Floating to LOW		7		s

Notes:

2. This parameter is guaranteed by design and characterization; not production tested.

3. $t_{DON}/t_{DOFF}/t_R/t_F$ is defined in Figure 5.

4. $t_{ON}=t_R + t_{DON}$.

5. $t_{OFF}=t_F + t_{DOFF}$.











FPF3003 — IntelliMAX™ Full Functional Input Power Path Management Switch for Dual-Batterv Portable Systems





Operation and Application Information

The FPF3003 is a low- R_{ON} , P-channel-based, inputsource-selection power management switch for dualbattery systems. The FPF3003 input operating range is from 2.3V to 5.5V on BATA and BATB, while ADPIN has a range of 4.6V to 5.5V.

The FPF3003 controls the charging path from the charger to the battery with up to 1.5A and the discharging path from the battery to system load with up to 2.5A. The system or PMIC selects one of two batteries to provide power and enables one of the batteries to be charged by the external battery charger.

The FPF3003 has 30µs slew-rate control to reduce inrush current when engaged and thermal shutdown protection for reliable system operation.

The internal circuit is powered from the highest voltage source among BATA, BATB, and ADPIN.

Battery Presence Detection

The FPF3003 monitors whether or not a battery is present via the BATAID and BATBID pins. If any of these pins are LOW; FPF3003 recognizes the battery is present. Each pin is connected with an internal LDO output, so no pull-up resistor is required.

Output Capacitor

During battery source transition, voltage droop depends on output capacitance and load current condition. Advanced break-before-make operation minimizes the droop with minimum capacitance. At least 10μ F is a good starting value in design.

Primary Battery Under-Voltage Set

FPF3003 monitors the primary battery of BATA for under-voltage condition. Once under-voltage condition is confirmed, the system power source changes from BATA to valid BATB automatically.

The under-voltage threshold level can be programmed with 0.8V of LOBAT and R divider (R1 and R2) as:

$$\frac{R1}{R2} = \frac{BATA_LO}{0.8} - 1$$
 (1)

where BATA_LO = Low BATA threshold to set.

If 3.4V of BATA is desired, R1/R2=3.25. If R2 is chosen 1M Ω , R1 is 3.25M Ω . Higher R2 is recommended to reduce leakage current from BATA.



Figure 35. BATA Under-Voltage Level Setting

LOBAT has a 1.3ms of deglitch time to ensure BATA is in true under-voltage rather than transient battery voltage drop during GSM transmission operation.

Battery Selection

The load path can be controlled by the BATSEL pin. When BATSEL is LOW, the system is powered from BATA. When BATSEL is HIGH, BATB powers the system.

Figure 36 is state diagram showing how the power path from battery to system is determined.



Figure 36. Power Path from Battery to System

The open-drain STAT pin is used to determine which battery powers the system. STAT becomes LOW if BATB is connected to the system. STAT is HIGH (HI-Z) if BATA is connected.

www.fairchildsemi.com

Battery Charging Path Selection

The charging path can be controlled by the CHGSEL pin. When CHGSEL is LOW, BATA can be charged from the charger. When CHGSEL is HIGH, BATB can be charged from the charger.



System RESET

The RESETB pin allows the system to be turned off without detaching the battery pack. It has typical 7s delay to avoid transient abnormal signal.

Board Layout

For best performance, all power traces (BATA, BATB, CHGIN, ADPIN, and VOUT) should be as short as possible to minimize the parasitic electrical effects and the case-to-ambient thermal impedance. The output capacitor should be placed close to the device to minimize parasitic trace inductance.



Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.

FAIRCHILD SEMICONDUCTOR TRADEMARKS The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks. F-PFS™ PowerTrench® The Power Franchise® 2Cool^{TI} PowerXSTM AccuPower™ FRFET® wer Programmable Active Droop™ Global Power Resource[™] AX-CAPTM* OFET BitSiC™ GreenBridge™ TinyBoost™ Green FPS™ OSTM. Build it Now™ TinyBuck™ Green FPS™ e-Series™ Quiet Series™ CorePLUS™ TinyCalc™ **CorePOWER™** RapidConfigure™ Gmax™ TinyLogic **GTO™** CROSSVOLT TINYOPTOT IntelliMAX CTL™ Saving our world, 1mW/W/kW at a time™ TinyPower™ ISOPI ANART Current Transfer Logic™ SignalWise™ TinyPWM™ Making Small Speakers Sound Louder DEUXPEED® SmartMax™ TinyWire™ and Better Dual Cool™ SMART START Tran SIC™ EcoSPARK[®] MegaBuck^{TI} Solutions for Your Success™ TriFault Detect™ MICROCOUPLER™ EfficientMax™ SPM® TRUECURRENT®* MicroFET™ **ESBC™** STEALTH[™] u.SerDes™ MicroPak™ (R) SuperFET[®] MicroPak2™ SuperSOT™-3 Fairchild® MillerDrive™ SuperSOT™-6 UHC Fairchild Semiconductor® Motion Max™ SuperSOT™-8 Ultra FRFET™ FACT Quiet Series™ mWSaver™ SupreMOS[®] UniFET FACT OptoHiT™ FAST® SyncFET™ VCX™ **OPTOLOGIC®** Sync-Lock™ FastyCore™ VisualMax™ **OPTOPLANAR® FETBench™** VoltagePlus™ FlashWriter®* XST læ FPST * Trademarks of System General Corporation, used under license by Fairchild Semiconductor. DISCLAIMER FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS. LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Surces. Fairchild is committed to combat this global problem and encourage our customers to by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms					
Datasheet Identification	Product Status	Definition			
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.			
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.			
No Identification Needed Full Production		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.			
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.			

Rev. 162

PF3003

— IntelliMAX[™] Full Functional Input Power Path Management Switch for Dual-Batterv Portable Systems

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC